Dual N-Channel Enhancement Mode Power MOSFET

Description

The JTM8205 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

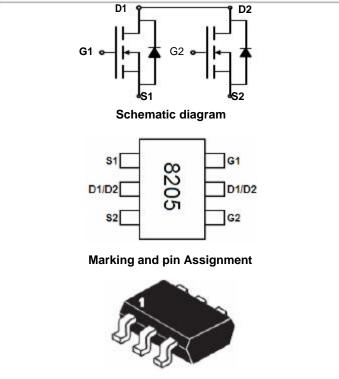
VDS = 19.5V,ID = 4A
RDS(ON) <37mΩ @ VGS=2.5V
RDS(ON) < 27mΩ @ VGS=4.5V

- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

Application

- Battery protection
- Load switch
- Power management

Package Marking And Ordering Information



SOT23-6L top view

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
8205	JTM8205	SOT23-6L	Ø180mm	8mm	3000 units

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	19.5	V
Gate-Source Voltage	Vgs	±10	V
Drain Current-Continuous	lo	4	A
Drain Current-Pulsed (Note 1)	Ідм	25	A
Maximum Power Dissipation	PD	1.25	W
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	Reja	100	°C /W
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Electrical Characteristics (TA=25 $^\circ\!\!\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	Vgs=0V Ip=250µA	19.5	21	-	V
Zero Gate Voltage Drain Current	ldss	VDS=19.5V,VGS=0V	-	-	1	μA

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Gate-Body Leakage Current	lgss	Vgs=±10V,Vds=0V	-	-	±100	nA
On Characteristics (Note 3)			•	•		
Gate Threshold Voltage	VGS(th)	Vds=Vgs,Id=250µA	0.5	0.7	1.2	V
Drain-Source On-State Resistance	Rds(on)	Vgs=4.5V, Id=4A	-	21	27	mΩ
		Vgs=2.5V, Id=3A	-	27	37	mΩ
Forward Transconductance	gfs	VDs=5V,ID=4A	-	10	-	S
Dynamic Characteristics (Note4)		·		•		
Input Capacitance	Clss	VDS=8V,VGS=0V,	-	800	-	PF
Output Capacitance	Coss	F=1.0MHz	-	155	-	PF
Reverse Transfer Capacitance	Crss	1 = 1.000112	-	125	-	PF
Switching Characteristics (Note 4)		·		•		
Turn-on Delay Time	td(on)		-	18	-	nS
Turn-on Rise Time	tr	Vdd=10V,Id=1A	-	5	-	nS
Turn-Off Delay Time	td(off)	Vgs=4V,Rgen=10Ω	-	43	-	nS
Turn-Off Fall Time	tr		-	20	-	nS
Total Gate Charge	Qg	Vos=10V,Io=4A,	-	11	-	nC
Gate-Source Charge	Qgs	VGS=4.5V	-	2.3	-	nC
Gate-Drain Charge	Qgd	VGS=4.5V	-	2.5	-	nC
Drain-Source Diode Characteristics					•	
Diode Forward Voltage (Note 3)	Vsd	Vgs=0V,Is=2A	-	0.8	1.2	V
Diode Forward Current (Note 2)	ls		-	-	2	А

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

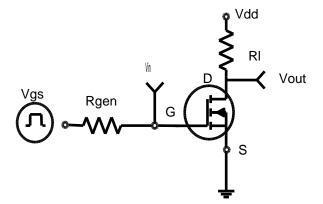
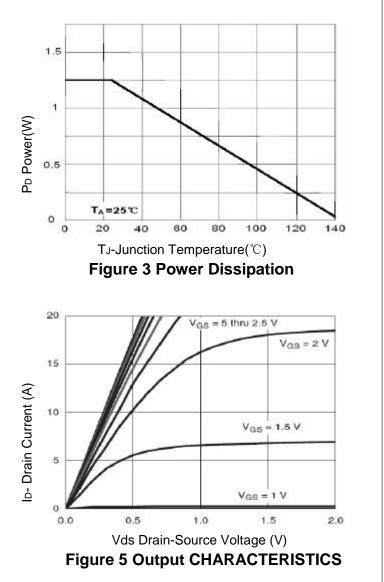
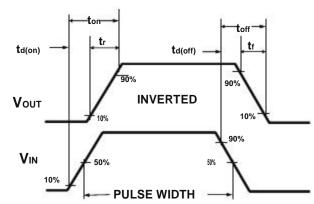
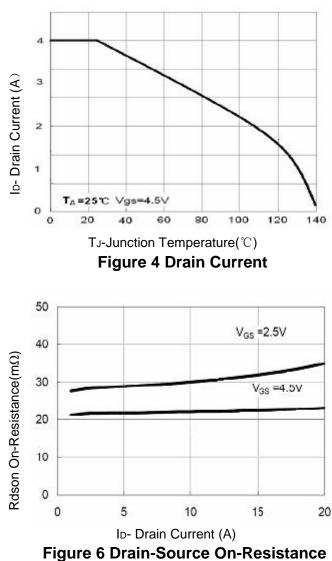


Figure 1:Switching Test Circuit



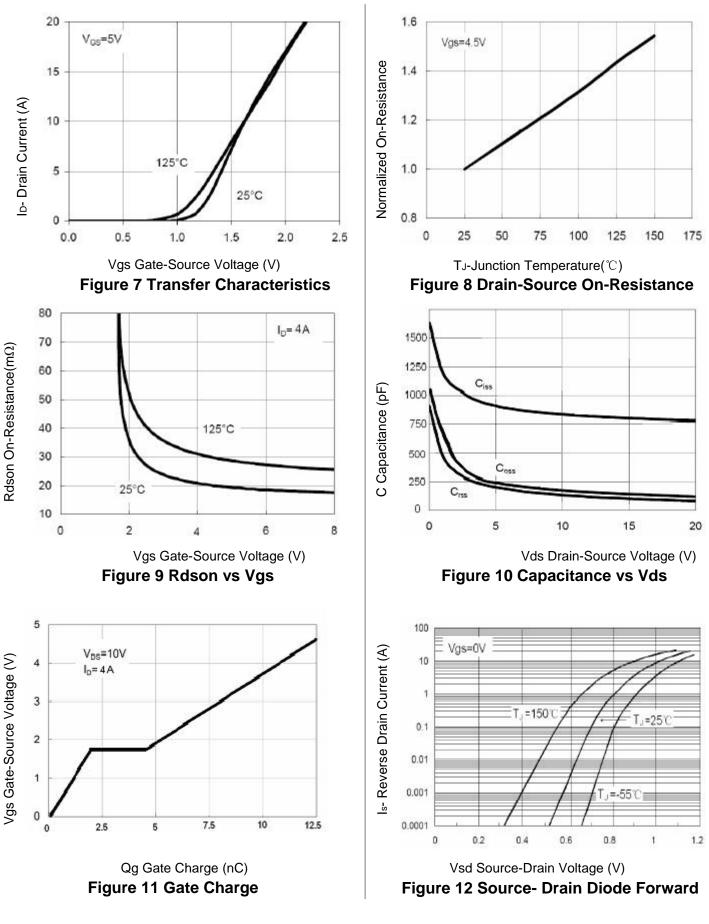






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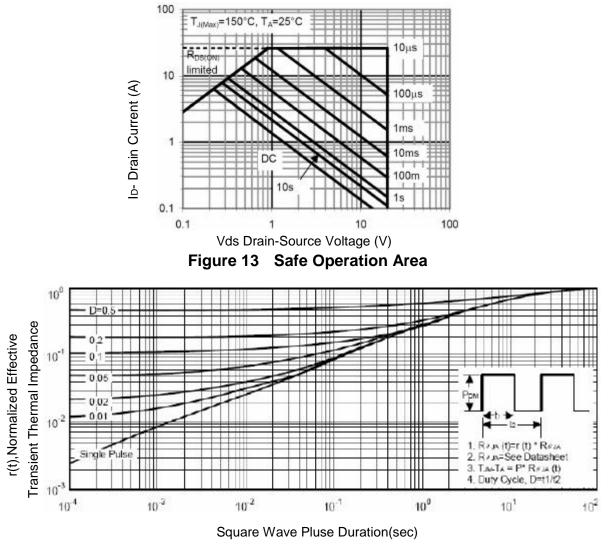
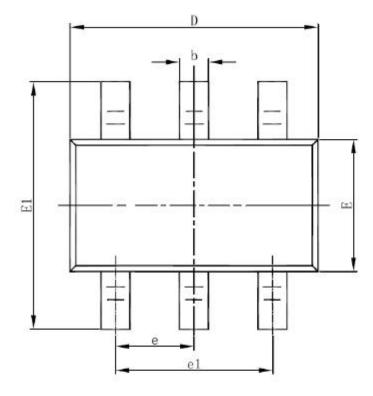
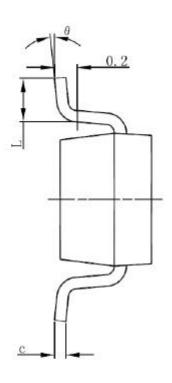


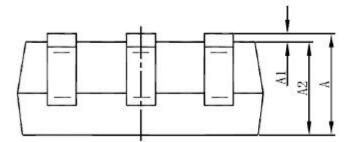
Figure 14 Normalized Maximum Transient Thermal Impedance

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Cumbed.	Dimensions Ir	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950(BSC)		0.037(BSC)		
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

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